

## Low Noise 150 mA LDO Regulator

No. EA-258-180621

### OUTLINE

The RP112x is a voltage regulator (LDO) with high output voltage accuracy, low-supply current, low On-resistance transistor, low noise output voltage and high ripple rejection. Each IC is composed of the followings: a voltage reference unit, an error amplifier, a resistor-net for output voltage setting, a current limit circuit, and a chip enable circuit.

The RP112x features ultra-low noise and its Ripple Rejection is as low as 80 dB at  $f = 1$  kHz, 75 dB at  $f = 10$  kHz and 65 dB at  $f = 100$  kHz. The Output Noise is also as low as Typ. 10  $\mu$ Vrms. It is kept the low level at any Output Voltage. RP112x is suitable for the power source for the portable music player and RF module that demands for higher level of noise reduction. SOT-23-5 and SC-88A packages, a 1-mm square DFN(PLP)1010-4 package are available.

### FEATURES

- Supply Current ..... Typ. 75  $\mu$ A
- Standby Current ..... Typ. 0.1  $\mu$ A
- Dropout Voltage ..... Typ. 0.20 V ( $I_{OUT} = 150$  mA,  $V_{OUT} = 2.8$  V)
- Ripple Rejection ..... Typ. 80 dB ( $f = 1$  kHz)  
Typ. 75 dB ( $f = 10$  kHz)  
Typ. 65 dB ( $f = 100$  kHz)
- Output Voltage Accuracy .....  $\pm 1.0\%$
- Output Voltage Temperature Coefficient ..... Typ.  $\pm 30$  ppm/ $^{\circ}$ C
- Line Regulation ..... Typ. 0.02%/V
- Packages ..... DFN(PLP)1010-4, SC-88A, SOT-23-5
- Input Voltage Range ..... 2.0 V to 5.25 V
- Output Voltage Range ..... 1.2 V to 4.8 V (0.1 V step)
- Short Current Limit ..... Typ. 40 mA
- Built-in Foldback Protection Circuit
- Output Noise ..... Typ. 10  $\mu$ Vrms
- Ceramic capacitors are recommended to be used with this IC ..... 1.0  $\mu$ F or more

### APPLICATIONS

- Power source for portable communication equipment.
- Power source for electrical appliances such as cameras, VCRs and camcorders.
- Power source for battery-powered equipments.
- Power source for electrical home appliances.
- Power source for the portable music player
- Power source for RF module

## SELECTION GUIDE

The output voltage, auto-discharge function<sup>(1)</sup>, package for the ICs can be selected at the user's request.

### Selection Guide

| Product Name     | Package        | Quantity per Reel | Pb Free | Halogen Free |
|------------------|----------------|-------------------|---------|--------------|
| RP112Kxx1*-TR    | DFN(PLP)1010-4 | 10,000 pcs        | Yes     | Yes          |
| RP112Qxx2*-TR-FE | SC-88A         | 3,000 pcs         | Yes     | Yes          |
| RP112Nxx1*-TR-FE | SOT-23-5       | 3,000 pcs         | Yes     | Yes          |

xx: Set output voltage ( $V_{SET}$ ) is selectable from 1.2 V to 4.8 V in 0.1 V step.

The second decimal point of the voltage is described as below.

1.25 V: RP112x12x\*5

1.85 V: RP112x18x\*5

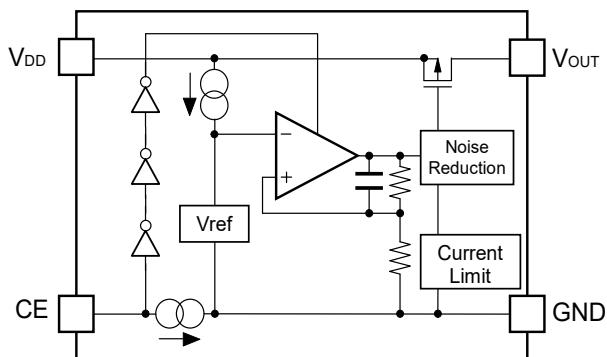
2.85 V: RP112x28x\*5

\*: Selections of CE pin polarity and Auto-discharge function are as shown below:

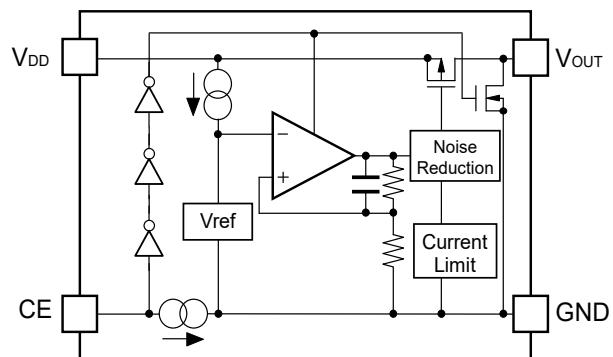
(B) CE pin polarity: "H" active, Auto-discharge function: No

(D) CE pin polarity: "H" active, Auto-discharge function: Yes

## BLOCK DIAGRAMS



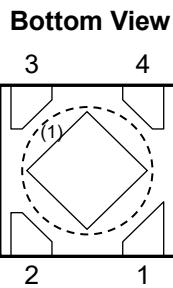
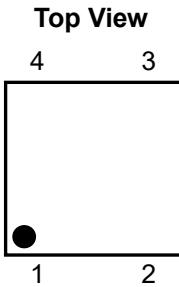
RP112xxxxB Block Diagram



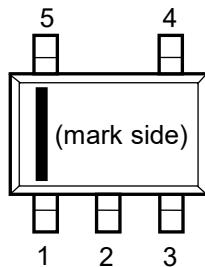
RP112xxxxD Block Diagram

<sup>(1)</sup> Auto-discharge function quickly lowers the output voltage to 0 V by releasing the electrical charge in the external capacitor when the chip enable signal is switched from the active mode to the standby mode.

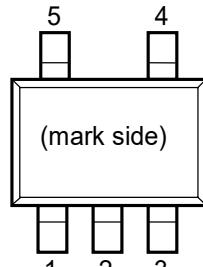
## PIN DESCRIPTIONS



DFN(PLP)1010-4 Pin Configuration



SC-88A Pin Configuration



SOT-23-5 Pin Configuration

### DFN(PLP)1010-4 Pin Description

| Pin No. | Symbol           | Description                  |
|---------|------------------|------------------------------|
| 1       | V <sub>OUT</sub> | Output Pin                   |
| 2       | GND              | Ground Pin                   |
| 3       | CE               | Chip Enable Pin ("H" Active) |
| 4       | V <sub>DD</sub>  | Input Pin                    |

### SC-88A Pin Description

| Pin No | Symbol           | Pin Description              |
|--------|------------------|------------------------------|
| 1      | V <sub>DD</sub>  | Input Pin                    |
| 2      | GND              | Ground Pin                   |
| 3      | CE               | Chip Enable Pin ("H" Active) |
| 4      | NC               | No Connection                |
| 5      | V <sub>OUT</sub> | Output Pin                   |

### SOT-23-5 Pin Description

| Pin No | Symbol           | Pin Description              |
|--------|------------------|------------------------------|
| 1      | V <sub>DD</sub>  | Input Pin                    |
| 2      | GND              | Ground Pin                   |
| 3      | CE               | Chip Enable Pin ("H" Active) |
| 4      | NC               | No Connection                |
| 5      | V <sub>OUT</sub> | Output Pin                   |

(1) Tab is GND level (They are connected to the reverse side of this IC). The tab is better to be connected to the GND, but leaving it open is also acceptable.

## ABSOLUTE MAXIMUM RATINGS

### Absolute Maximum Ratings

| Symbol           | Item                       | Rating                               | Unit |
|------------------|----------------------------|--------------------------------------|------|
| V <sub>IN</sub>  | Input Voltage              | 6.0                                  | V    |
| V <sub>CE</sub>  | Input Voltage (CE Pin)     | 6.0                                  | V    |
| V <sub>OUT</sub> | Output Voltage             | -0.3 to V <sub>IN</sub> + 0.3        | V    |
| I <sub>OUT</sub> | Output Current             | 180                                  | mA   |
| P <sub>D</sub>   | (DFN(PLP)1010-4)           | JEDEC STD. 51-7<br>Test Land Pattern | 800  |
|                  | SC-88A                     | Standard<br>Test Land Pattern        | 380  |
|                  | SOT-23-5                   | JEDEC STD. 51-7<br>Test Land Pattern | 660  |
| T <sub>j</sub>   | Junction Temperature Range | -40 to 125                           | C    |
| T <sub>stg</sub> | Storage Temperature Range  | -55 to 125                           | °C   |

### ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the life time and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

## RECOMMENDED OPERATING CONDITIONS

### Recommended Operating Conditions

| Symbol          | Item                  | Rating      | Unit |
|-----------------|-----------------------|-------------|------|
| V <sub>IN</sub> | Input Voltage         | 2.0 to 5.25 | V    |
| T <sub>a</sub>  | Operating Temperature | -40 to 85   | °C   |

### RECOMMENDED OPERATING CONDITIONS

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

<sup>(1)</sup> Refer to *POWER DISSIPATION* for detailed information.

## ELECTRICAL CHARACTERISTICS

Unless otherwise noted,  $V_{IN} = 5.25 \text{ V}$  ( $V_{OUT} \geq 4.1 \text{ V}$ ),  $V_{IN} = \text{Set } V_{OUT} + 1.0 \text{ V}$  ( $1.5 \text{ V} < V_{OUT} < 4.1 \text{ V}$ ),

$V_{IN} = 2.5 \text{ V}$  ( $V_{OUT} \leq 1.5 \text{ V}$ ),  $I_{OUT} = 1 \text{ mA}$ ,  $C_{IN} = C_{OUT} = 1.0 \mu\text{F}$

The specifications surrounded by   are guaranteed by design engineering at  $-40^\circ\text{C} \leq Ta \leq 85^\circ\text{C}$ .

### RP112xxxxB/D Electrical Characteristics

(Ta = 25°C)

| Symbol                          | Item                                   | Conditions  |  | Min.   | Typ.     | Max.          | Unit                          |
|---------------------------------|--|---|--|--------|----------|---------------|-------------------------------|
| $V_{OUT}$                       | Output Voltage                         | Ta = 25°C   | $V_{OUT} \geq 2.0 \text{ V}$                 | x0.99  |          | x1.01         | V                             |
|                                 |  |   | $V_{OUT} < 2.0 \text{ V}$                    | -20    |          | +20           | mV                            |
|                                 |  | $-40^\circ\text{C} \leq Ta \leq 85^\circ\text{C}$   | $V_{OUT} \geq 2.0 \text{ V}$                 | x0.985 |          | x1.015        | V                             |
|                                 |  |   | $V_{OUT} < 2.0 \text{ V}$                    | -30    |          | +30           | mV                            |
| $I_{OUT}$                       | Output Current                         |   |  | 150    |          |               | mA                            |
| $\Delta V_{OUT}/\Delta I_{OUT}$ | Load Regulation                        | $1 \text{ mA} \leq I_{OUT} \leq 150 \text{ mA}$   |  | -14    | 0        | 14            | mV                            |
| $V_{DIF}$                       | Dropout Voltage                        | Refer to Product-specific Electrical Characteristics  |  |        |          |               |                               |
| $I_{SS}$                        | Supply Current                         | $I_{OUT} = 0 \text{ mA}$  | $V_{OUT} \geq 4.1 \text{ V}$                 | 80     | 100      | $\mu\text{A}$ |                               |
|                                 |  |   | $V_{OUT} < 4.1 \text{ V}$                    |        |          |               |                               |
| $I_{standby}$                   | Standby Current                        | $V_{CE} = 0 \text{ V}$  |  |        | 0.1      | 1.0           | $\mu\text{A}$                 |
| $\Delta V_{OUT}/\Delta V_{IN}$  | Line Regulation                        | $\text{Set } V_{OUT} + 0.3 \text{ V} \leq V_{IN} \leq 5.25 \text{ V}$   | $V_{OUT} \geq 4.1 \text{ V}$                 | 0.02   | 0.10     | $\%/\text{V}$ |                               |
|                                 |  | $\text{Set } V_{OUT} + 0.5 \text{ V} \leq V_{IN} \leq 5.0 \text{ V}$  | $1.7 \text{ V} \leq V_{OUT} < 4.1 \text{ V}$ |        |          |               |                               |
|                                 |  | $2.2 \text{ V} \leq V_{IN} \leq 5.0 \text{ V}$  | $V_{OUT} < 1.7 \text{ V}$                    |        |          |               |                               |
| RR                              | Ripple Rejection                       | $\text{Ripple } 0.2 \text{ Vp-p},$<br>$I_{OUT} = 30 \text{ mA},$<br>$V_{IN} = 5.25 \text{ V}$<br>( $V_{OUT} \geq 4.1 \text{ V}$ ),<br>$V_{IN} = \text{Set } V_{OUT} + 1.0 \text{ V}$<br>( $V_{OUT} < 4.1 \text{ V}$ ) | $f = 1 \text{ kHz}$                          | 80     | 75       | 65            | dB                            |
|                                 |  |   | $f = 10 \text{ kHz}$                         |        |          |               |                               |
|                                 |  |   | $f = 100 \text{ kHz}$                        |        |          |               |                               |
| $V_{IN}$                        | Input Voltage <sup>(1)</sup>           |   |  | 2.0    |          | 5.25          | V                             |
| $\Delta V_{OUT}/\Delta T_a$     | Output Voltage Temperature Coefficient | $-40^\circ\text{C} \leq Ta \leq 85^\circ\text{C}$   |  |        | $\pm 30$ |               | $\text{ppm } /^\circ\text{C}$ |
| $I_{SC}$                        | Short Current Limit                    | $V_{OUT} = 0 \text{ V}$   |  |        | 40       |               | mA                            |
| $I_{PD}$                        | CE Pull-down Current                   |   |  |        | 0.3      | 0.6           | $\mu\text{A}$                 |
| $V_{CEH}$                       | CE Input Voltage "H"                   |   |  | 1.0    |          |               | V                             |
| $V_{CEL}$                       | CE Input Voltage "L"                   |   |  |        |          | 0.4           | V                             |

All test categories were tested on the products under the pulse load condition ( $T_j \approx Ta = 25^\circ\text{C}$ ) except Output Noise, Ripple Rejection, and Output Voltage Temperature Coefficient.

<sup>(1)</sup> The maximum input voltage (Electrical Characteristics) is 5.25 V. If, for any reason the maximum input voltage exceeds 5.25 V, it has to be no more than 5.5 V with 500 hrs of the total operating time.

## ELECTRICAL CHARACTERISTICS (continued)

Unless otherwise noted,  $V_{IN} = 5.25 \text{ V}$  ( $V_{OUT} \geq 4.1 \text{ V}$ ),  $V_{IN} = \text{Set } V_{OUT} + 1.0 \text{ V}$  ( $1.5 \text{ V} < V_{OUT} < 4.1 \text{ V}$ ),

$V_{IN} = 2.5 \text{ V}$  ( $V_{OUT} \leq 1.5 \text{ V}$ ),  $I_{OUT} = 1 \text{ mA}$ ,  $C_{IN} = C_{OUT} = 1.0 \mu\text{F}$

The specifications surrounded by    are guaranteed by design engineering at  $-40^\circ\text{C} \leq Ta \leq 85^\circ\text{C}$ .

**RP112xxxxB/D Electrical Characteristics**

( $T_a = 25^\circ\text{C}$ )

| Symbol    | Item   | Conditions  | Min. | Typ. | Max. | Unit             |
|-----------|--|---|------|------|------|------------------|
| en        | Output Noise   | $BW = 10 \text{ Hz to } 100 \text{ kHz}$ ,<br>$I_{OUT} = 30 \text{ mA}$ |      | 10   |      | $\mu\text{Vrms}$ |
| $R_{LOW}$ | Auto-discharge Nch Tr.<br>ON Resistance<br>(RP112xxxxD only) | $V_{IN} = 4.0 \text{ V}$ , $V_{CE} = 0 \text{ V}$                       |      | 60   |      | $\Omega$         |

All test categories were tested on the products under the pulse load condition ( $T_j \approx T_a = 25^\circ\text{C}$ ) except Output Noise, Ripple Rejection, and Output Voltage Temperature Coefficient.

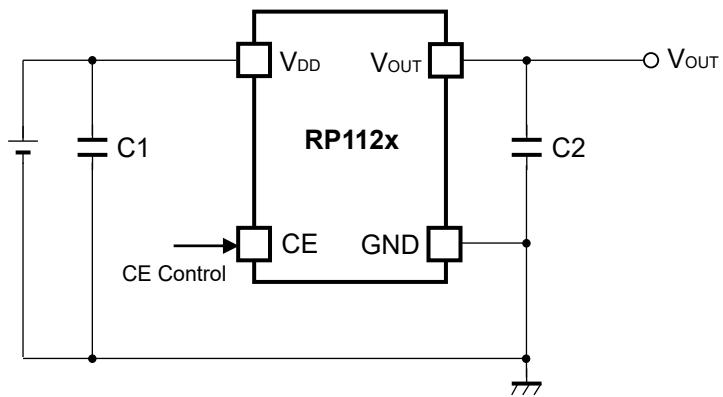
The specifications surrounded by  are guaranteed by design engineering at  $-40^{\circ}\text{C} \leq \text{Ta} \leq 85^{\circ}\text{C}$ .

#### Product-specific Electrical Characteristics

| Product Name | $V_{\text{OUT}}$                 |      |       |  |      |       | $V_{\text{DIF}}$                 |      |
|--------------|----------------------------------|------|-------|--|------|-------|----------------------------------|------|
|              | $\text{Ta} = 25^{\circ}\text{C}$ |      |       | $-40^{\circ}\text{C} \leq \text{Ta} \leq 85^{\circ}\text{C}$ |      |       | $\text{Ta} = 25^{\circ}\text{C}$ |      |
|              | Min.                             | Typ. | Max.  | Min.   | Typ. | Max.  | Typ.                             | Max. |
| RP112x12xx   | 1.180                            | 1.20 | 1.220 | 1.170  | 1.20 | 1.230 | 0.39                             | 0.80 |
| RP112x12xx5  | 1.230                            | 1.25 | 1.270 | 1.220  | 1.25 | 1.280 | 0.39                             | 0.80 |
| RP112x13xx   | 1.280                            | 1.30 | 1.320 | 1.270  | 1.30 | 1.330 | 0.37                             | 0.70 |
| RP112x14xx   | 1.380                            | 1.40 | 1.420 | 1.370  | 1.40 | 1.430 | 0.34                             | 0.60 |
| RP112x15xx   | 1.480                            | 1.50 | 1.520 | 1.470  | 1.50 | 1.530 | 0.32                             | 0.50 |
| RP112x16xx   | 1.580                            | 1.60 | 1.620 | 1.570  | 1.60 | 1.630 | 0.32                             | 0.50 |
| RP112x17xx   | 1.680                            | 1.70 | 1.720 | 1.670  | 1.70 | 1.730 | 0.29                             | 0.41 |
| RP112x18xx   | 1.780                            | 1.80 | 1.820 | 1.770  | 1.80 | 1.830 | 0.29                             | 0.41 |
| RP112x18xx5  | 1.830                            | 1.85 | 1.870 | 1.820  | 1.85 | 1.880 | 0.29                             | 0.41 |
| RP112x19xx   | 1.880                            | 1.90 | 1.920 | 1.870  | 1.90 | 1.930 | 0.29                             | 0.41 |
| RP112x20xx   | 1.980                            | 2.00 | 2.020 | 1.970  | 2.00 | 2.030 | 0.25                             | 0.36 |
| RP112x21xx   | 2.079                            | 2.10 | 2.121 | 2.069  | 2.10 | 2.132 | 0.25                             | 0.36 |
| RP112x22xx   | 2.178                            | 2.20 | 2.222 | 2.167  | 2.20 | 2.233 | 0.25                             | 0.36 |
| RP112x23xx   | 2.277                            | 2.30 | 2.323 | 2.266  | 2.30 | 2.335 | 0.25                             | 0.36 |
| RP112x24xx   | 2.376                            | 2.40 | 2.424 | 2.364  | 2.40 | 2.436 | 0.25                             | 0.36 |
| RP112x25xx   | 2.475                            | 2.50 | 2.525 | 2.463  | 2.50 | 2.538 | 0.22                             | 0.31 |
| RP112x26xx   | 2.574                            | 2.60 | 2.626 | 2.561  | 2.60 | 2.639 | 0.22                             | 0.31 |
| RP112x27xx   | 2.673                            | 2.70 | 2.727 | 2.660  | 2.70 | 2.741 | 0.22                             | 0.31 |
| RP112x28xx   | 2.772                            | 2.80 | 2.828 | 2.758  | 2.80 | 2.842 | 0.20                             | 0.28 |
| RP112x28xx5  | 2.822                            | 2.85 | 2.879 | 2.807  | 2.85 | 2.893 | 0.20                             | 0.28 |
| RP112x29xx   | 2.871                            | 2.90 | 2.929 | 2.857  | 2.90 | 2.944 | 0.20                             | 0.28 |
| RP112x29xx5  | 2.921                            | 2.95 | 2.980 | 2.906  | 2.95 | 2.994 | 0.20                             | 0.28 |
| RP112x30xx   | 2.970                            | 3.00 | 3.030 | 2.955  | 3.00 | 3.045 | 0.20                             | 0.28 |
| RP112x31xx   | 3.069                            | 3.10 | 3.131 | 3.054  | 3.10 | 3.147 | 0.20                             | 0.28 |
| RP112x31xx5  | 3.119                            | 3.15 | 3.182 | 3.103  | 3.15 | 3.197 | 0.20                             | 0.28 |
| RP112x32xx   | 3.168                            | 3.20 | 3.232 | 3.152  | 3.20 | 3.248 | 0.20                             | 0.28 |
| RP112x33xx   | 3.267                            | 3.30 | 3.333 | 3.251  | 3.30 | 3.350 | 0.20                             | 0.28 |
| RP112x34xx   | 3.366                            | 3.40 | 3.434 | 3.349  | 3.40 | 3.451 | 0.20                             | 0.28 |
| RP112x35xx   | 3.465                            | 3.50 | 3.535 | 3.448  | 3.50 | 3.553 | 0.20                             | 0.28 |
| RP112x36xx   | 3.564                            | 3.60 | 3.636 | 3.546  | 3.60 | 3.654 | 0.20                             | 0.28 |
| RP112x37xx   | 3.663                            | 3.70 | 3.737 | 3.645  | 3.70 | 3.756 | 0.20                             | 0.28 |
| RP112x38xx   | 3.762                            | 3.80 | 3.838 | 3.743  | 3.80 | 3.857 | 0.20                             | 0.28 |
| RP112x39xx   | 3.861                            | 3.90 | 3.939 | 3.842  | 3.90 | 3.959 | 0.20                             | 0.28 |
| RP112x40xx   | 3.960                            | 4.00 | 4.040 | 3.940  | 4.00 | 4.060 | 0.20                             | 0.28 |
| RP112x41xx   | 4.059                            | 4.10 | 4.141 | 4.039  | 4.10 | 4.162 | 0.20                             | 0.28 |
| RP112x42xx   | 4.158                            | 4.20 | 4.242 | 4.137  | 4.20 | 4.263 | 0.20                             | 0.28 |
| RP112x43xx   | 4.257                            | 4.30 | 4.343 | 4.236  | 4.30 | 4.365 | 0.20                             | 0.28 |
| RP112x44xx   | 4.356                            | 4.40 | 4.444 | 4.334  | 4.40 | 4.466 | 0.20                             | 0.28 |
| RP112x45xx   | 4.455                            | 4.50 | 4.545 | 4.433  | 4.50 | 4.568 | 0.20                             | 0.28 |
| RP112x46xx   | 4.554                            | 4.60 | 4.646 | 4.531  | 4.60 | 4.669 | 0.20                             | 0.28 |
| RP112x47xx   | 4.653                            | 4.70 | 4.747 | 4.630  | 4.70 | 4.771 | 0.20                             | 0.28 |
| RP112x48xx   | 4.752                            | 4.80 | 4.848 | 4.728  | 4.80 | 4.872 | 0.20                             | 0.28 |

## APPLICATION INFORMATION

### TYPICAL APPLICATIONS



### External Components

| Symbol           | Description   |
|------------------|---|
| C1 ( $C_{IN}$ )  | 1.0 $\mu$ F, Ceramic Capacitor, GRM155B31A105KE15, MURATA |
| C2 ( $C_{OUT}$ ) | 1.0 $\mu$ F, Ceramic Capacitor, GRM155B31A105KE15, MURATA |

## TECHNICAL NOTES

### Phase Compensation

In these ICs, phase compensation is made for securing stable operation even if the load current is varied. For this purpose, use a 1.0  $\mu$ F or more capacitor C2.

In case of using a tantalum capacitor, the output may be unstable due to inappropriate ESR. Therefore, the full range of operating conditions for the capacitor in the application should be considered.

### PCB Layout

The high impedances of  $V_{DD}$  and GND could be a reason for the noise pickup and unstable operation. Therefore, it is imperative that the impedances of  $V_{DD}$  and GND be the lowest possible. Also, place a 1.0  $\mu$ F or more capacitor (C1) between  $V_{DD}$  pin and GND pin as close as possible to each other.

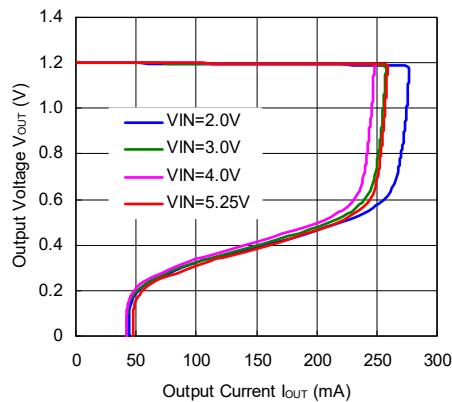
As for C2 output capacitor that is used for phase compensation, place it between  $V_{OUT}$  pin and GND as close as possible to each other (Refer to *TYPICAL APPLICATIONS*).

## TYPICAL CHARACTERISTICS

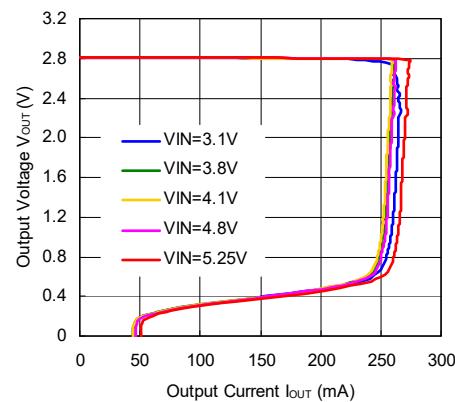
Typical Characteristics are intended to be used as reference data; they are not guaranteed.

### 1) Output Voltage vs. Output Current (C1 = Ceramic 1.0 $\mu$ F, C2 = Ceramic 1.0 $\mu$ F, Ta = 25°C)

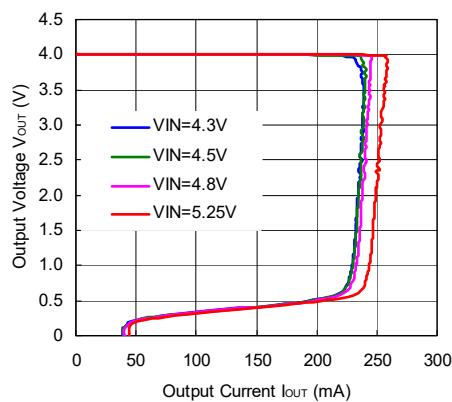
RP112x12xx



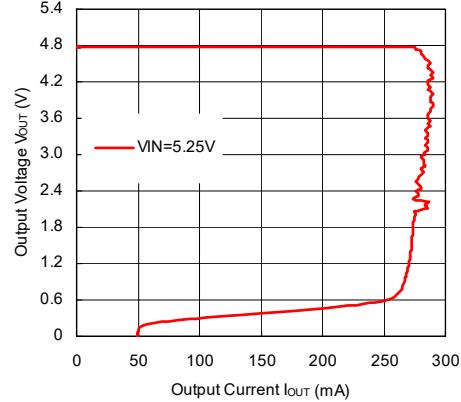
RP112x28xx



RP112x40xx

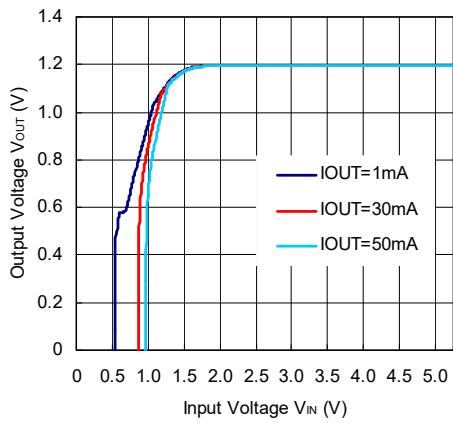


RP112x48xx

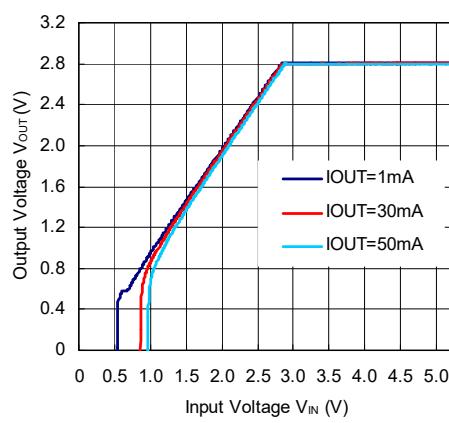


### 2) Output Voltage vs. Input Voltage (C1 = Ceramic 1.0 $\mu$ F, C2 = Ceramic 1.0 $\mu$ F, Ta = 25°C)

RP112x12xx



RP112x28xx

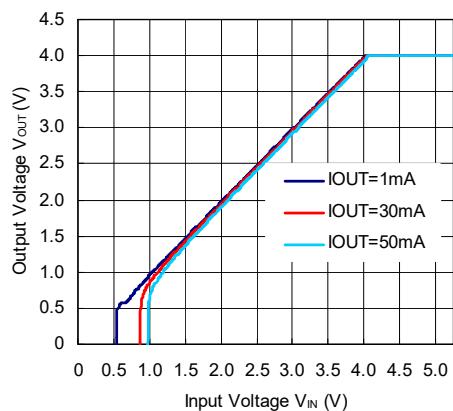


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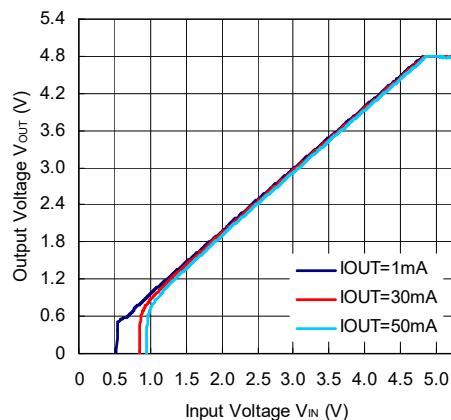
## RP112x

No. EA-258-180621

**RP112x40xx**

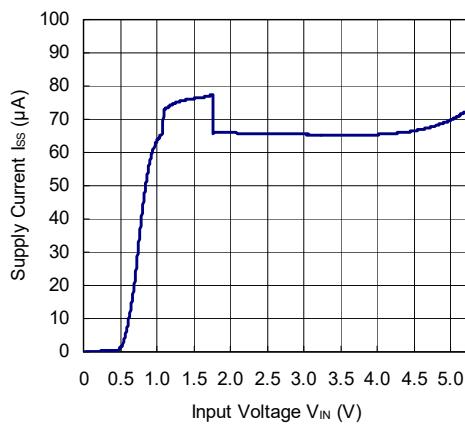


**RP112x48xx**

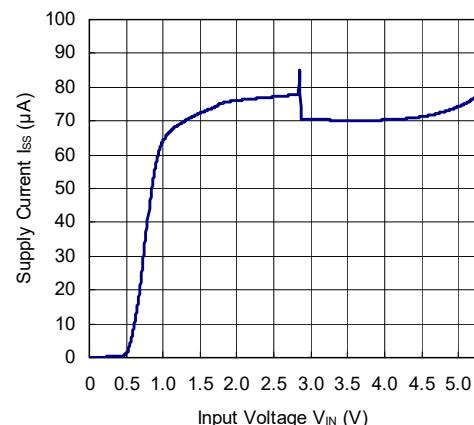


### 3) Supply Current vs. Input Voltage (C1 = Ceramic 1.0 $\mu\text{F}$ , C2 = Ceramic 1.0 $\mu\text{F}$ , Ta = 25°C)

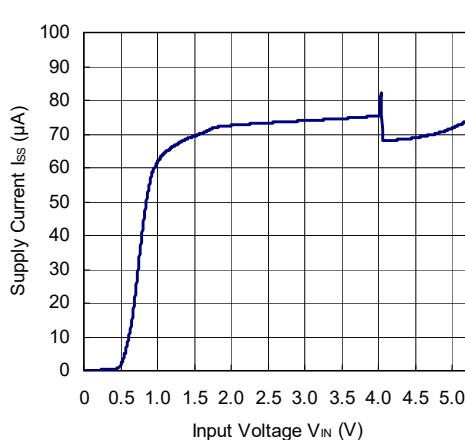
**RP112x12xx**



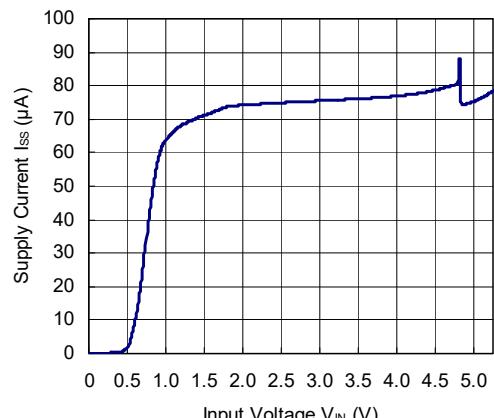
**RP112x28xx**



**RP112x40xx**

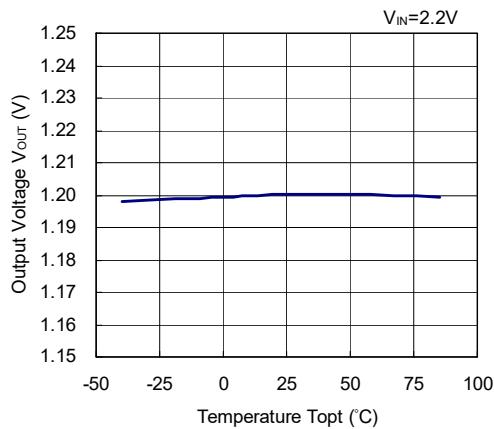


**RP112x48xx**

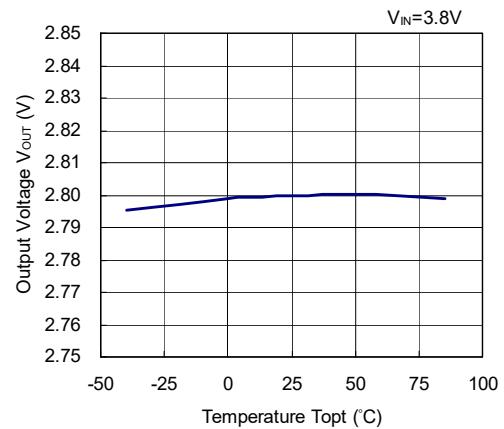


4) Output Voltage vs. Temperature (C1 = Ceramic 1.0  $\mu$ F, C2 = Ceramic 1.0  $\mu$ F, I<sub>OUT</sub> = 1 mA)

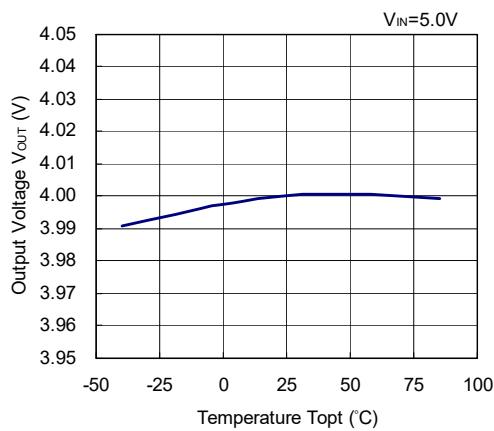
RP112x12xx



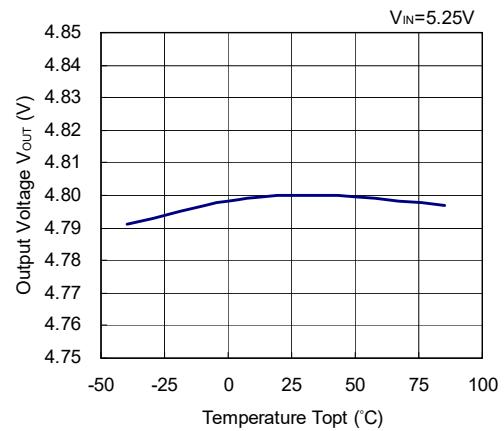
RP112x28xx



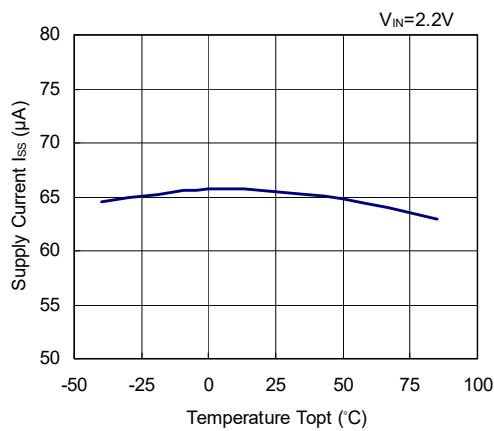
RP112x40xx



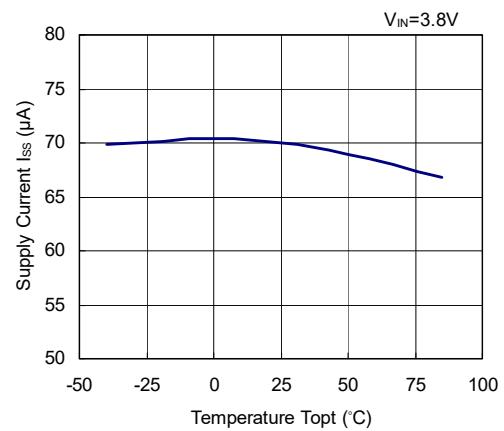
RP112x48xx

5) Supply Current vs. Temperature (C1 = Ceramic 1.0  $\mu$ F, C2 = Ceramic 1.0  $\mu$ F, I<sub>OUT</sub> = 0 mA)

RP112x12xx



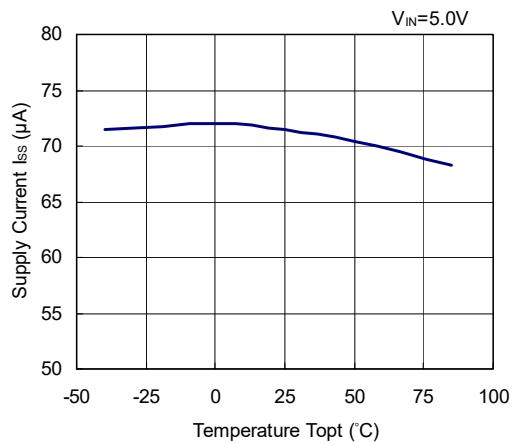
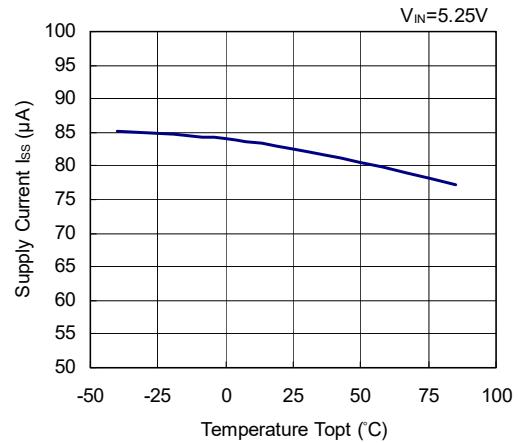
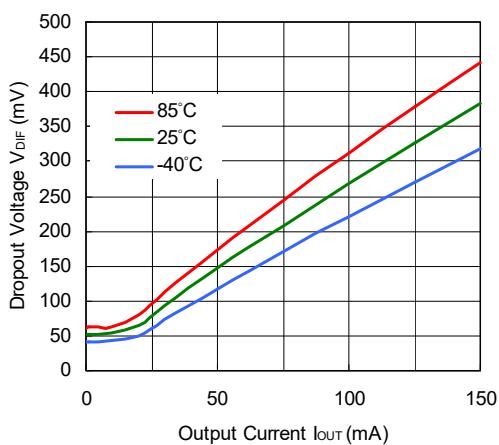
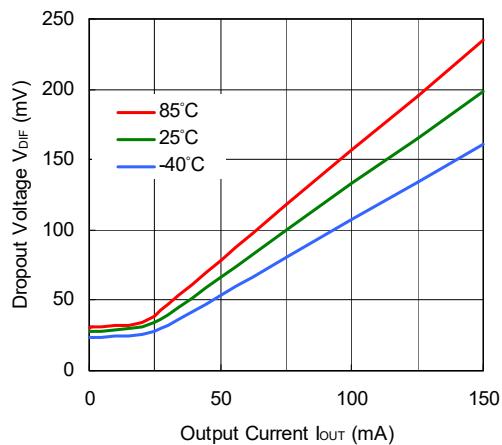
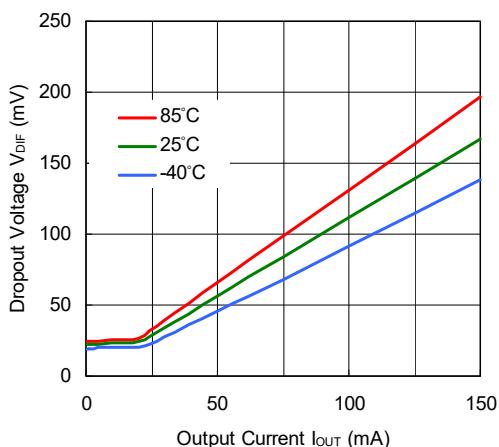
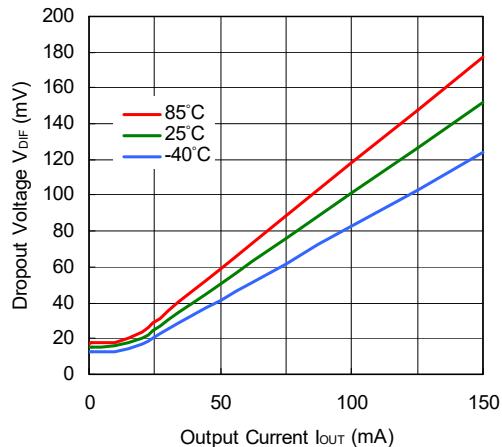
RP112x28xx



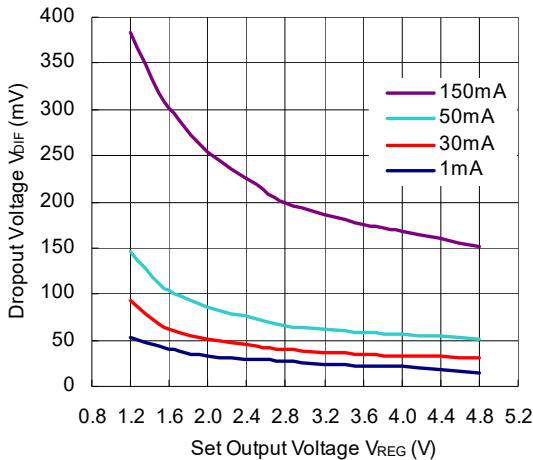
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**RP112x**

No. EA-258-180621

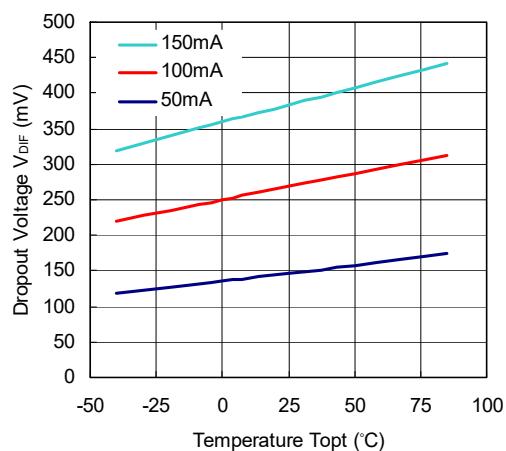
**RP112x40xx****RP112x48xx****6) Dropout Voltage vs. Output Current ( $C_1 = \text{Ceramic } 1.0 \mu\text{F}, C_2 = \text{Ceramic } 1.0 \mu\text{F}$ )****RP112x12xx****RP112x28xx****RP112x40xx****RP112x48xx**

**7) Dropout Voltage vs. Set Output Voltage (C1 = Ceramic 1.0  $\mu$ F, C2 = Ceramic 1.0  $\mu$ F, Ta = 25°C)**

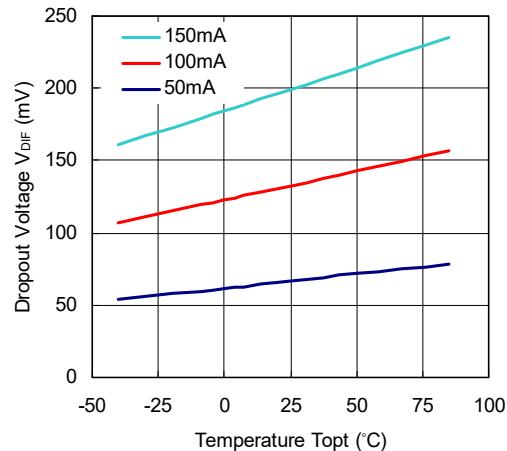


**8) Dropout Voltage vs. Temperature (C1 = Ceramic 1.0  $\mu$ F, C2 = Ceramic 1.0  $\mu$ F)**

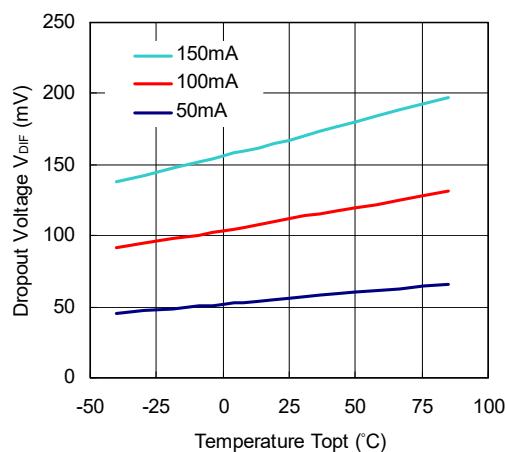
RP112x12xx



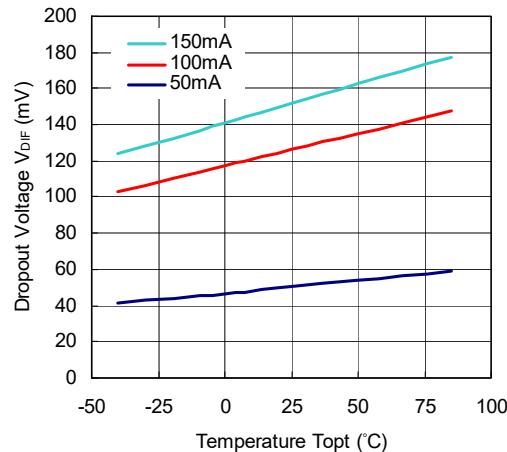
RP112x28xx



RP112x40xx



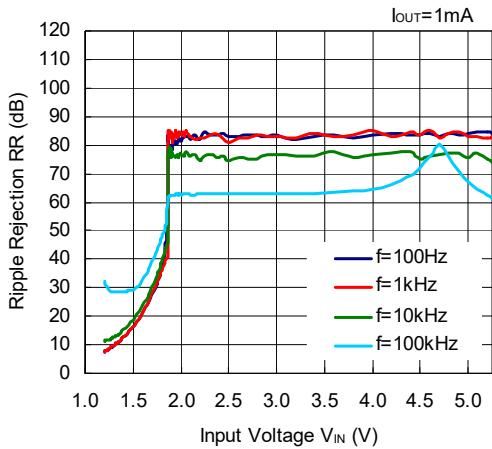
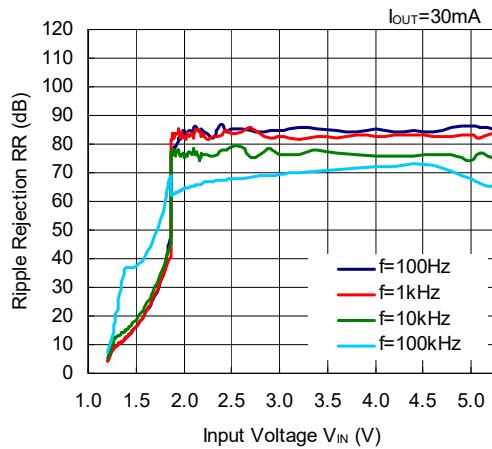
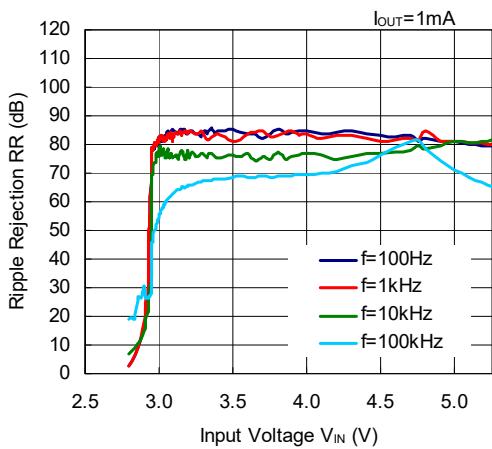
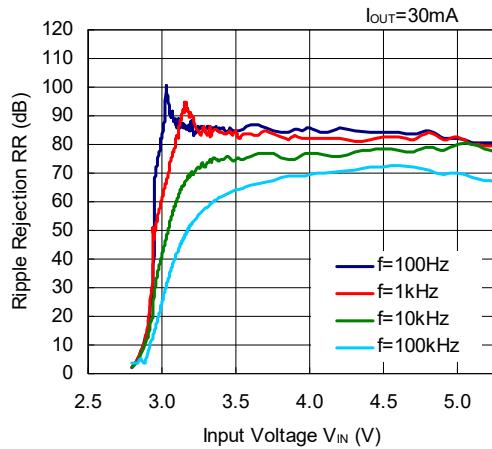
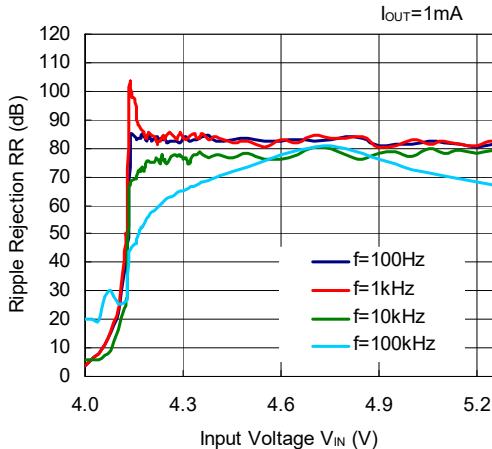
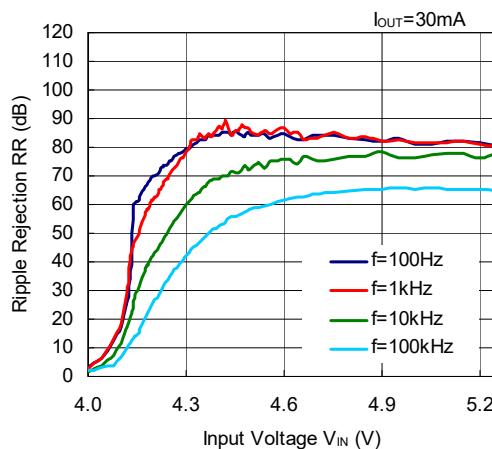
RP112x48xx



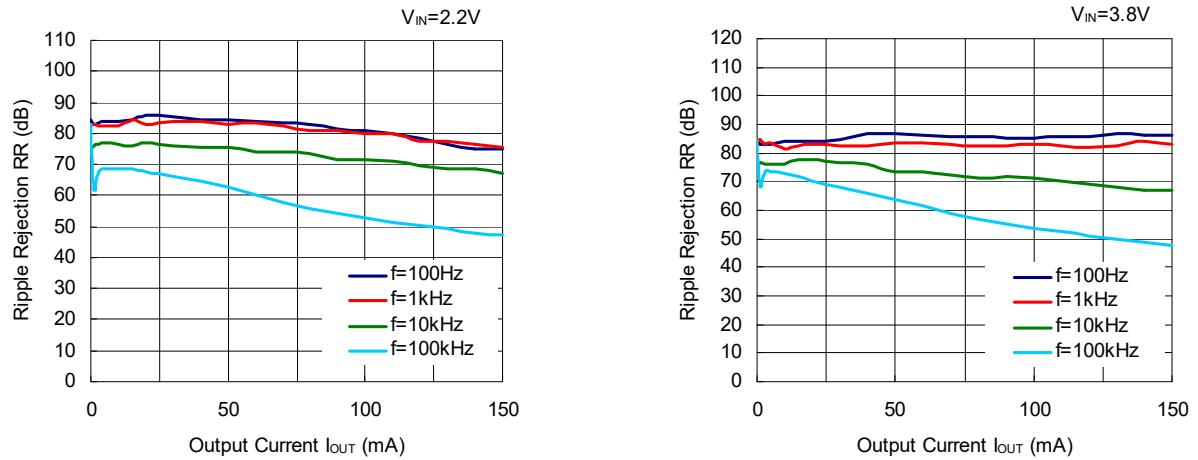
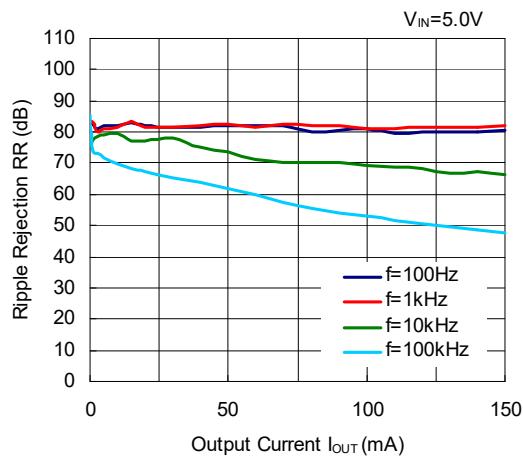
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**RP112x**

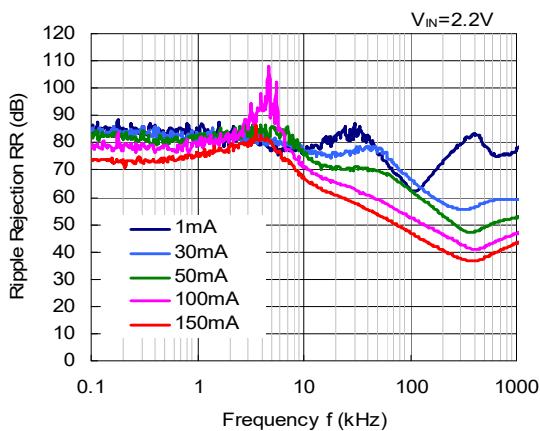
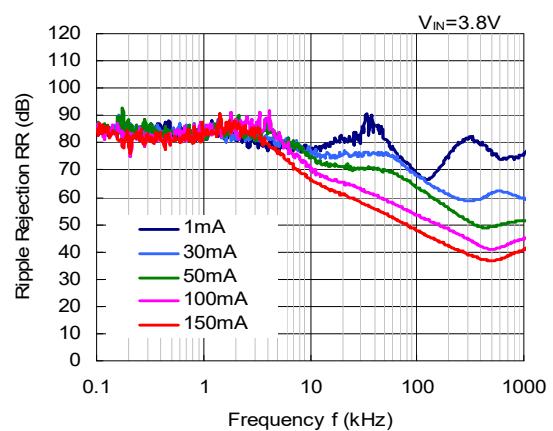
No. EA-258-180621

**9) Ripple Rejection vs. Input Voltage (C1 = none, C2 = Ceramic 1.0  $\mu$ F, Ripple = 0.2 Vp-p, Ta = 25°C)****RP112x12xx****RP112x12xx****RP112x28xx****RP112x28xx****RP112x40xx****RP112x40xx**

**10) Ripple Rejection vs. Output Current (C1 = none, C2 = Ceramic 1.0 $\mu$ F, Ripple = 0.2 Vp-p, Ta = 25°C)**  
**RP112x12xx**      **RP112x28xx**

**RP112x40xx**

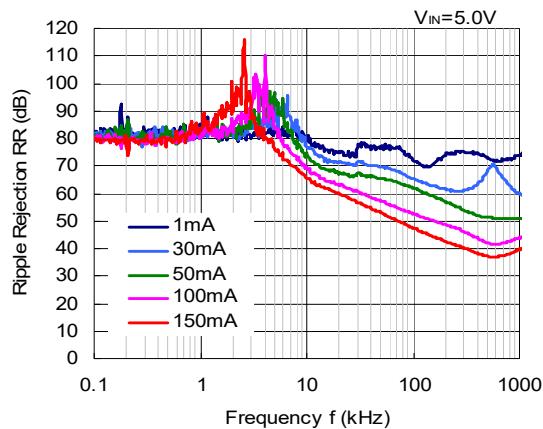
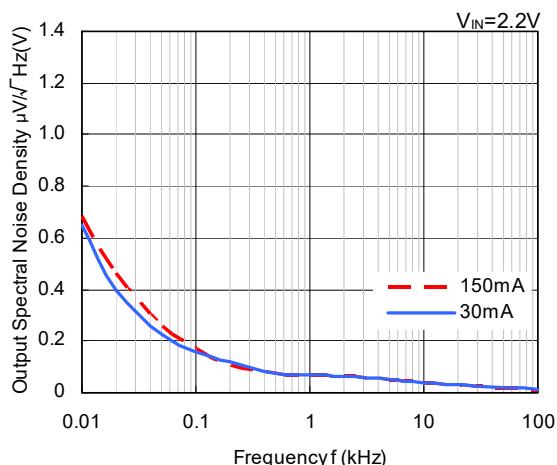
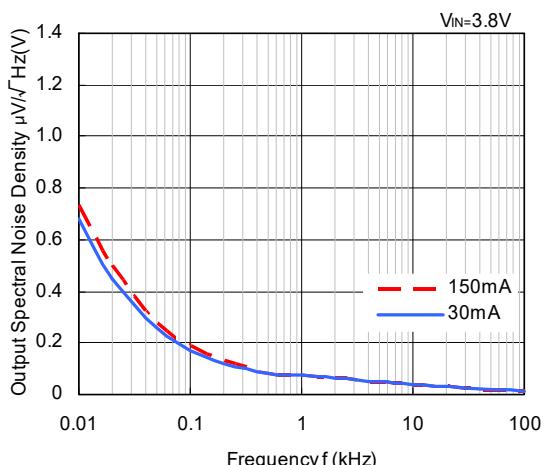
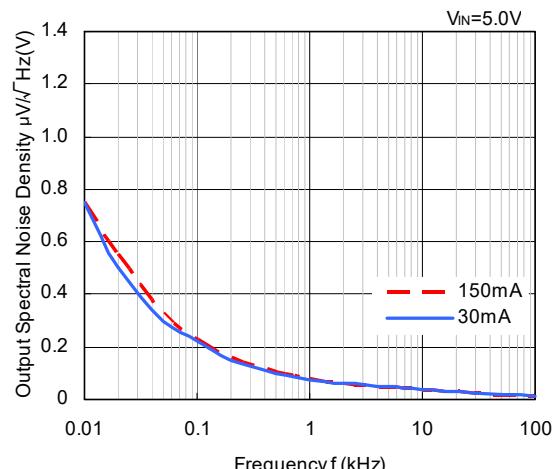
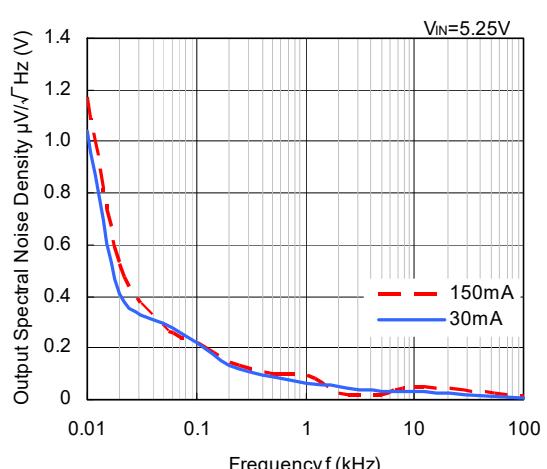
**11) Ripple Rejection vs. Frequency (C1 = none, C2 = Ceramic 1.0  $\mu$ F, Ripple = 0.2 Vp-p, Ta = 25°C)**

**RP112x12xx****RP112x28xx**

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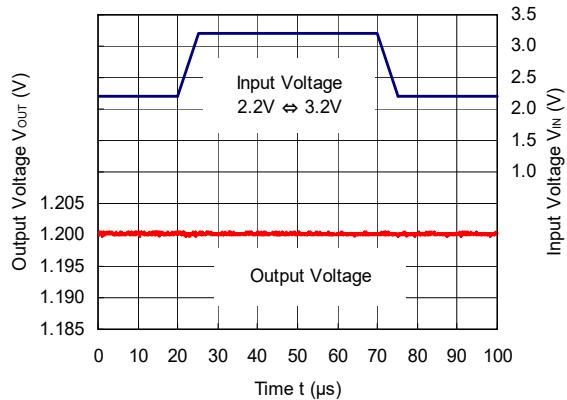
**RP112x**

No. EA-258-180621

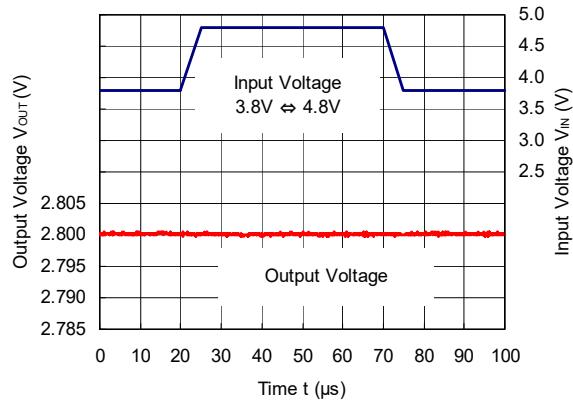
**RP112x40xx****12) Output Spectral Noise Density vs. Frequency (C1 = none, C2 = Ceramic 1.0  $\mu$ F, Ta = 25°C)****RP112x12xx****RP112x28xx****RP112x40xx****RP112x48xx**

13) Input Transient Response (C1 = none, C2 = Ceramic 1.0  $\mu$ F, I<sub>OUT</sub> = 30mA, tr = tf = 5.0  $\mu$ s, Ta = 25°C)

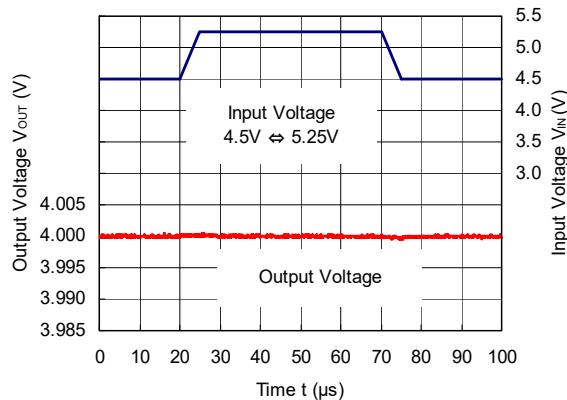
RP112x12xx



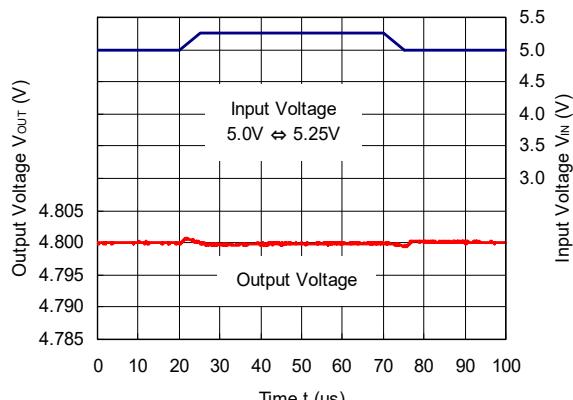
RP112x28xx



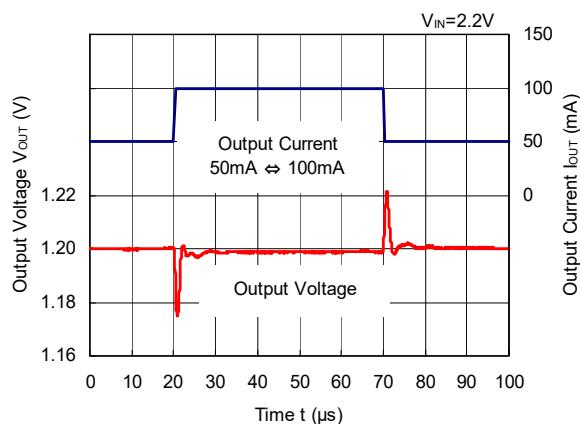
RP112x40xx



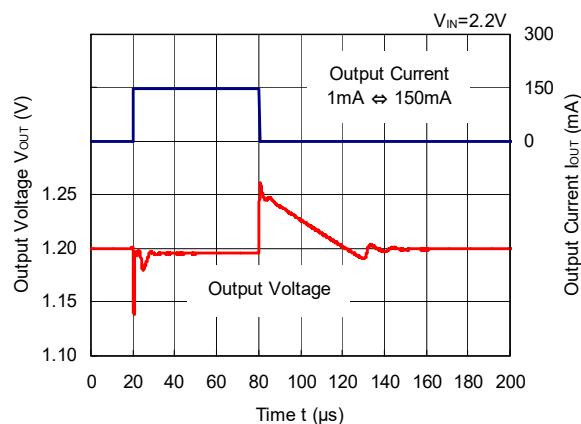
RP112x48xx

14) Load Transient Response (C1 = Ceramic 1.0  $\mu$ F, C2 = Ceramic 1.0  $\mu$ F, tr = tf = 0.5  $\mu$ s, Ta = 25°C)

RP112x12xx



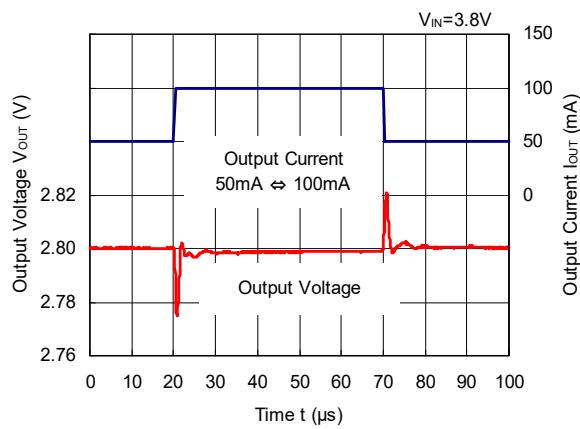
RP112x12xx



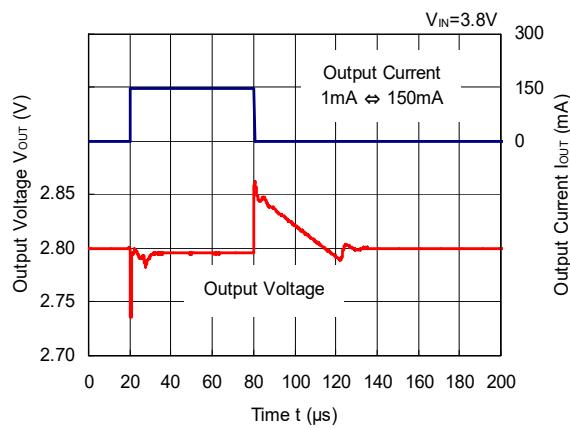
## RP112x

No. EA-258-180621

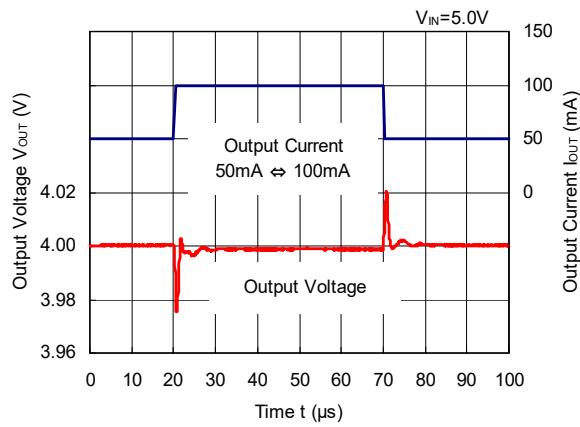
**RP112x28xx**



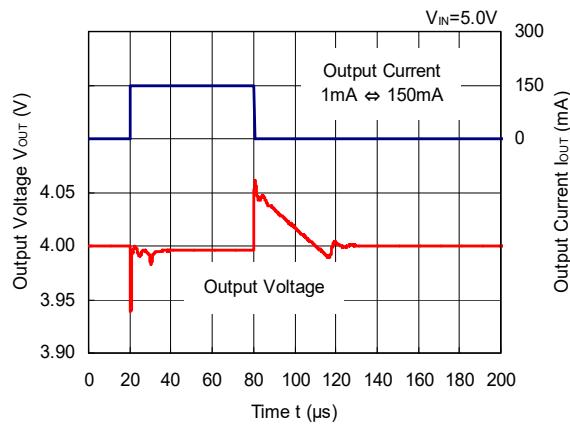
**RP112x28xx**



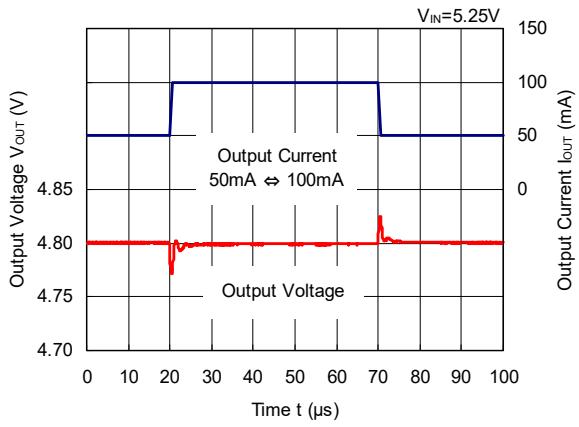
**RP112x40xx**



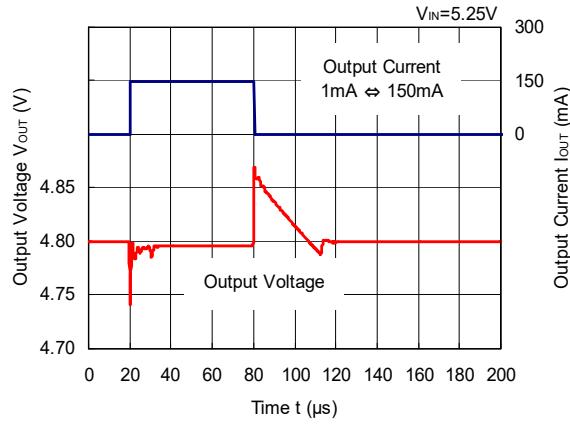
**RP112x40xx**



**RP112x48xx**

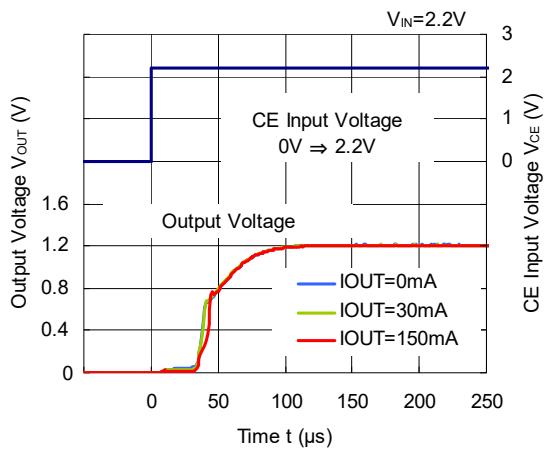


**RP112x48xx**

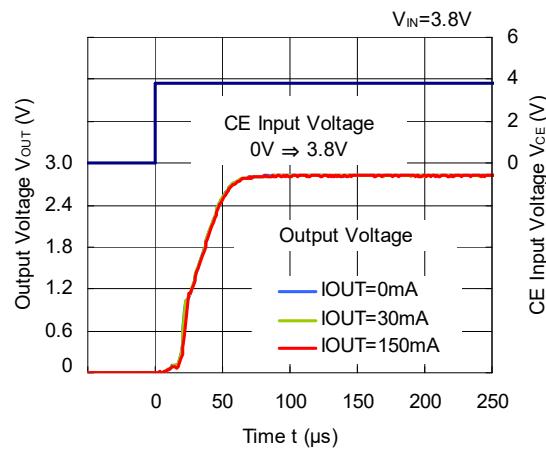


15) Turn on Speed with CE pin (C1 = Ceramic 1.0  $\mu$ F, C2 = Ceramic 1.0  $\mu$ F, Ta = 25°C)

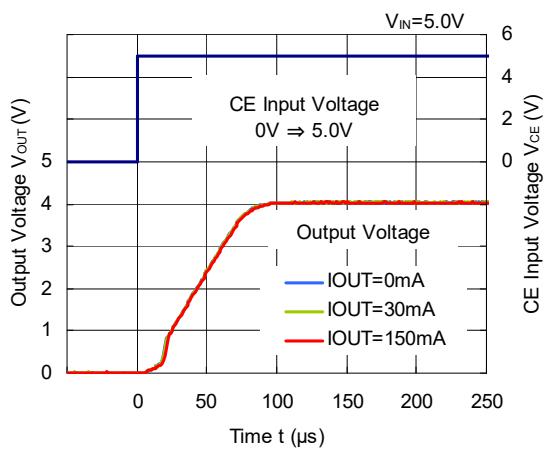
RP112x12xx



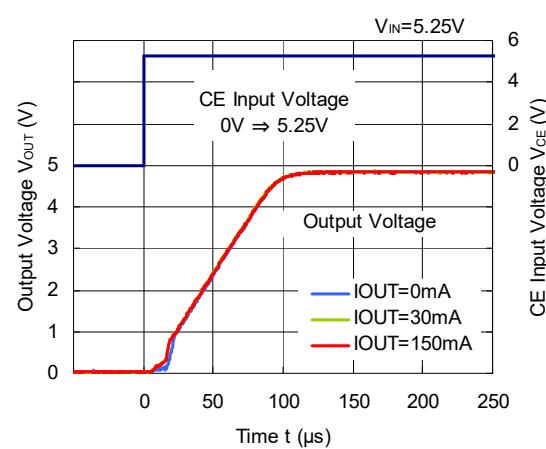
RP112x28xx



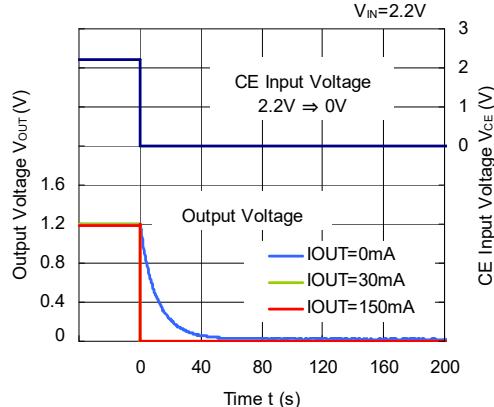
RP112x40xx



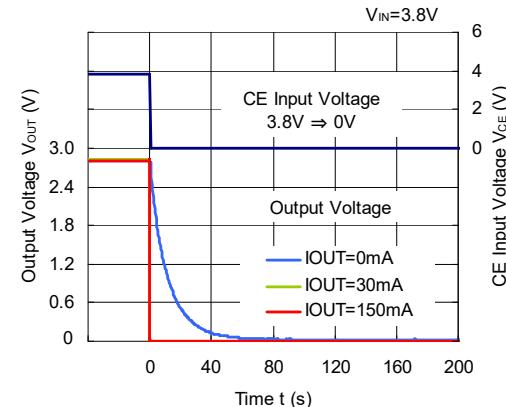
RP112x48xx

16) Turn off Speed with CE pin (RP112xxxxB) (C1 = Ceramic 1.0  $\mu$ F, C2 = Ceramic 1.0  $\mu$ F, Ta = 25°C)

RP112x12xx



RP112x28xx

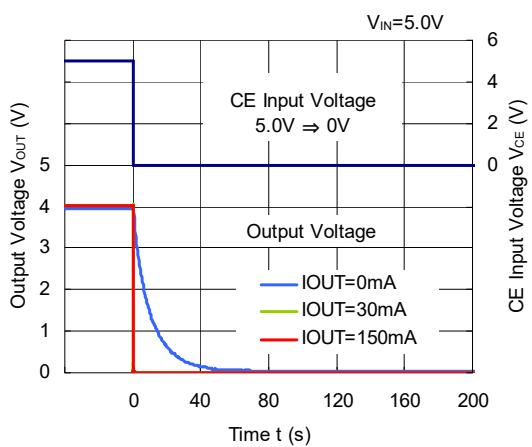


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## RP112x

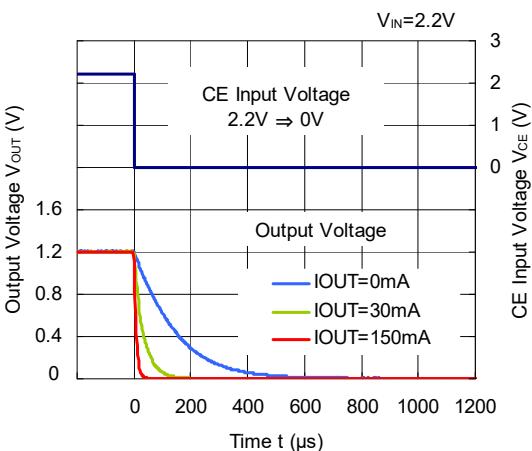
No. EA-258-180621

**RP112x40xB**

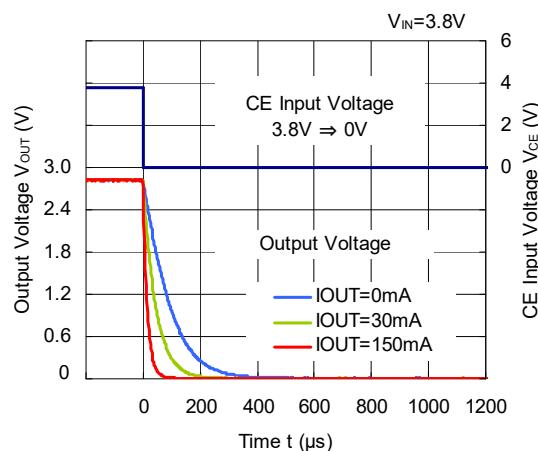


**17) Turn off Speed with CE pin (RP112xxxxD) ( $C_1 = \text{Ceramic } 1.0 \mu\text{F}$ ,  $C_2 = \text{Ceramic } 1.0 \mu\text{F}$ ,  $T_a = 25^\circ\text{C}$ )**

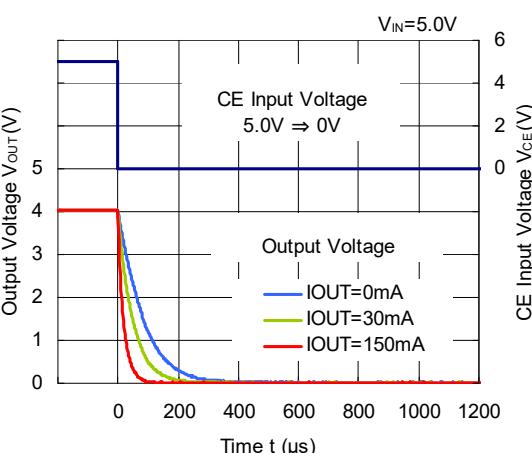
**RP112x12xD**



**RP112x28xD**

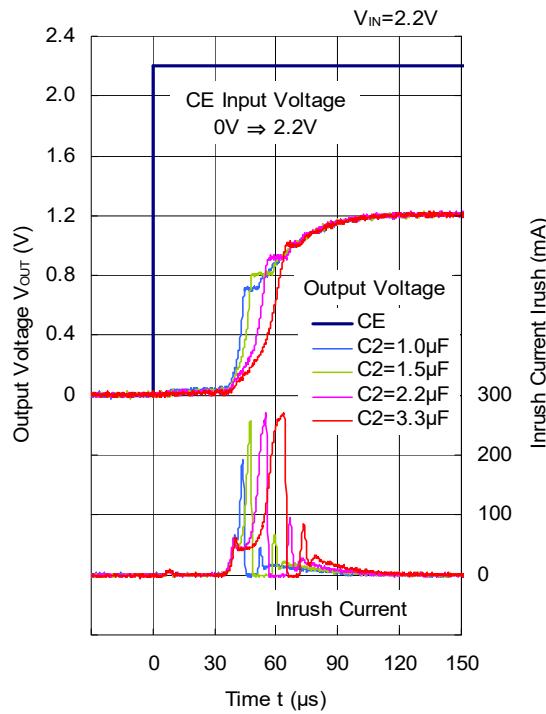


**RP112x40xD**

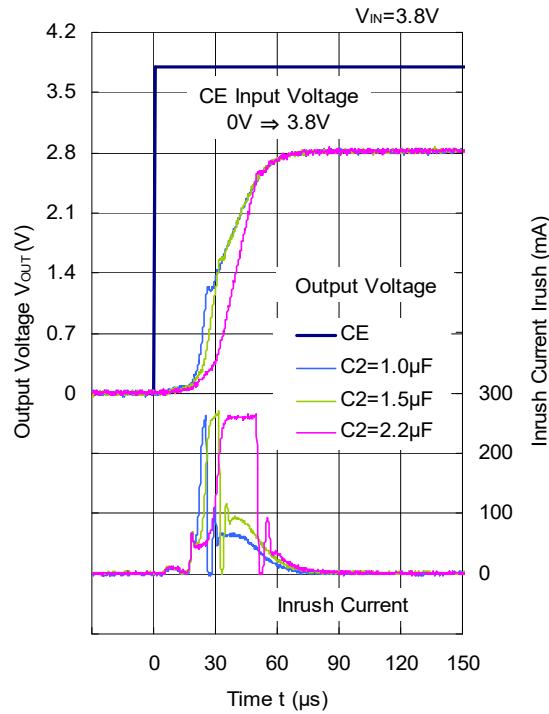


18) Inrush Current ( $C_1 = \text{Ceramic } 1.0 \mu\text{F}$ ,  $I_{\text{OUT}} = 0 \text{ mA}$ ,  $T_a = 25^\circ\text{C}$ )

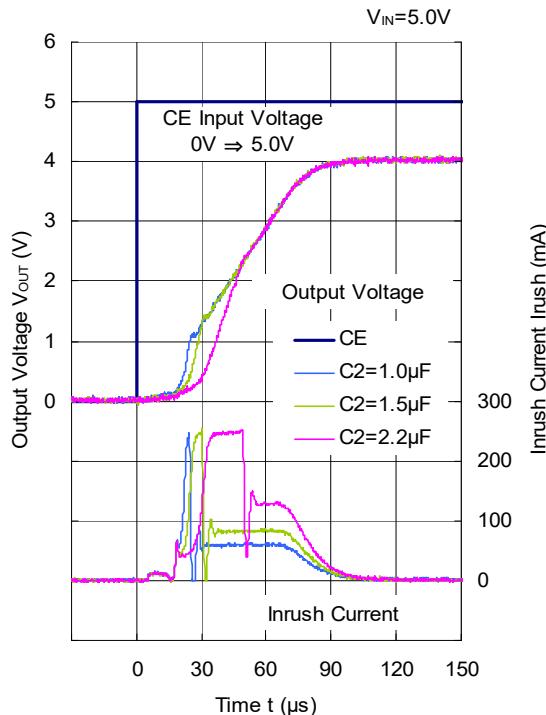
RP112x12xx



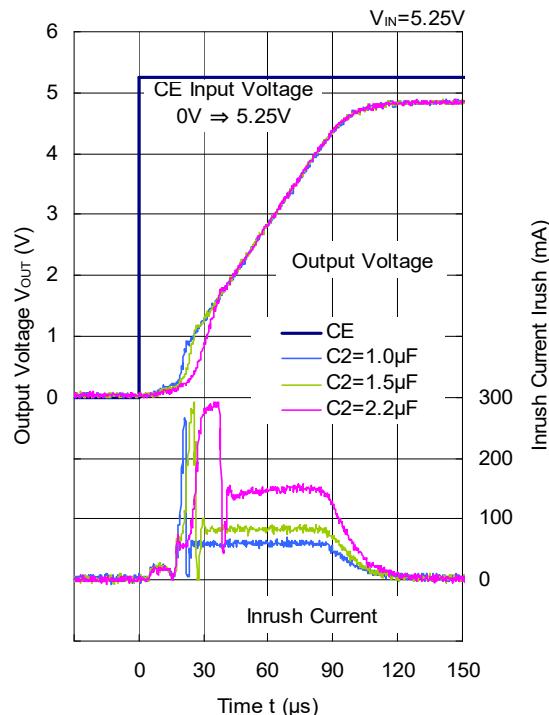
RP112x28xx



RP112x40xx



RP112x48xx



## Equivalent Series Resistance vs. Output Current

When using these ICs, consider the following points:

The relations between  $I_{OUT}$  (Output Current) and ESR of an output capacitor are shown below.

The conditions when the white noise level is under 40  $\mu$ V (Avg.) are marked as the hatched area in the graph.

### Measurement Conditions

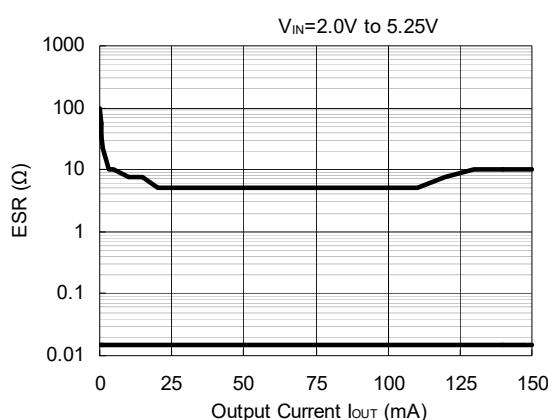
Frequency Band: 10 Hz to 2 MHz

Temperature: -40°C to 85°C

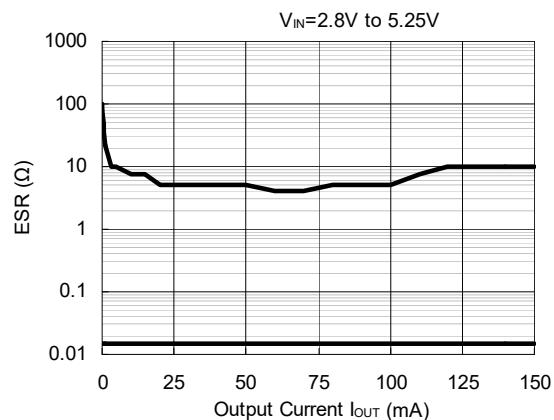
Hatched Area: Noise level is under 40  $\mu$ V (Avg.)

C1, C2: 1.0  $\mu$ F or more

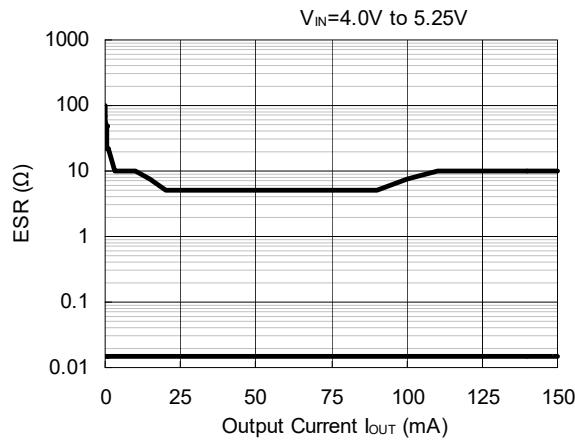
**RP112x12xx**



**RP112x28xx**



**RP112x40xx**



The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

#### Measurement Conditions

| Item             | Measurement Conditions   |
|------------------|--|
| Environment      | Mounting on Board (Wind Velocity = 0 m/s)  |
| Board Material   | Glass Cloth Epoxy Plastic (Four-Layer Board)   |
| Board Dimensions | 76.2 mm × 114.3 mm × 0.8 mm  |
| Copper Ratio     | Outer Layer (First Layer): Less than 95% of 50 mm Square<br>Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square<br>Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square |
| Through-holes    | φ 0.2 mm × 11 pcs  |

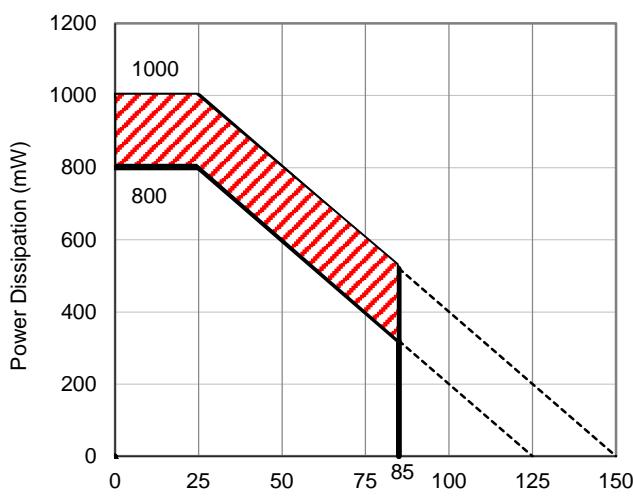
#### Measurement Result

(Ta = 25°C, Tjmax = 125°C)

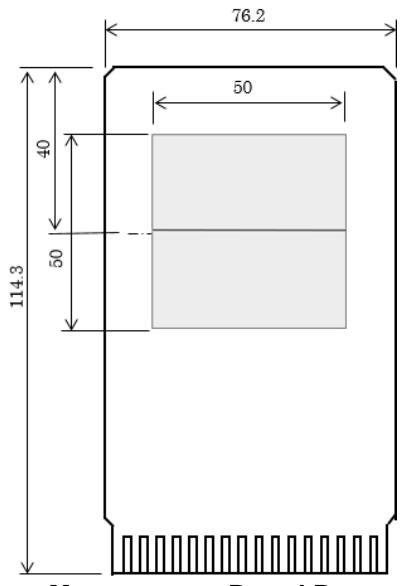
| Item   | Measurement Result                         |
|--|--|
| Power Dissipation                                  | 800 mW                                     |
| Thermal Resistance ( $\theta_{ja}$ )               | $\theta_{ja} = 125^\circ\text{C}/\text{W}$ |
| Thermal Characterization Parameter ( $\psi_{jt}$ ) | $\psi_{jt} = 58^\circ\text{C}/\text{W}$    |

$\theta_{ja}$ : Junction-to-Ambient Thermal Resistance

$\psi_{jt}$ : Junction-to-Top Thermal Characterization Parameter



Power Dissipation vs. Ambient Temperature



Measurement Board Pattern

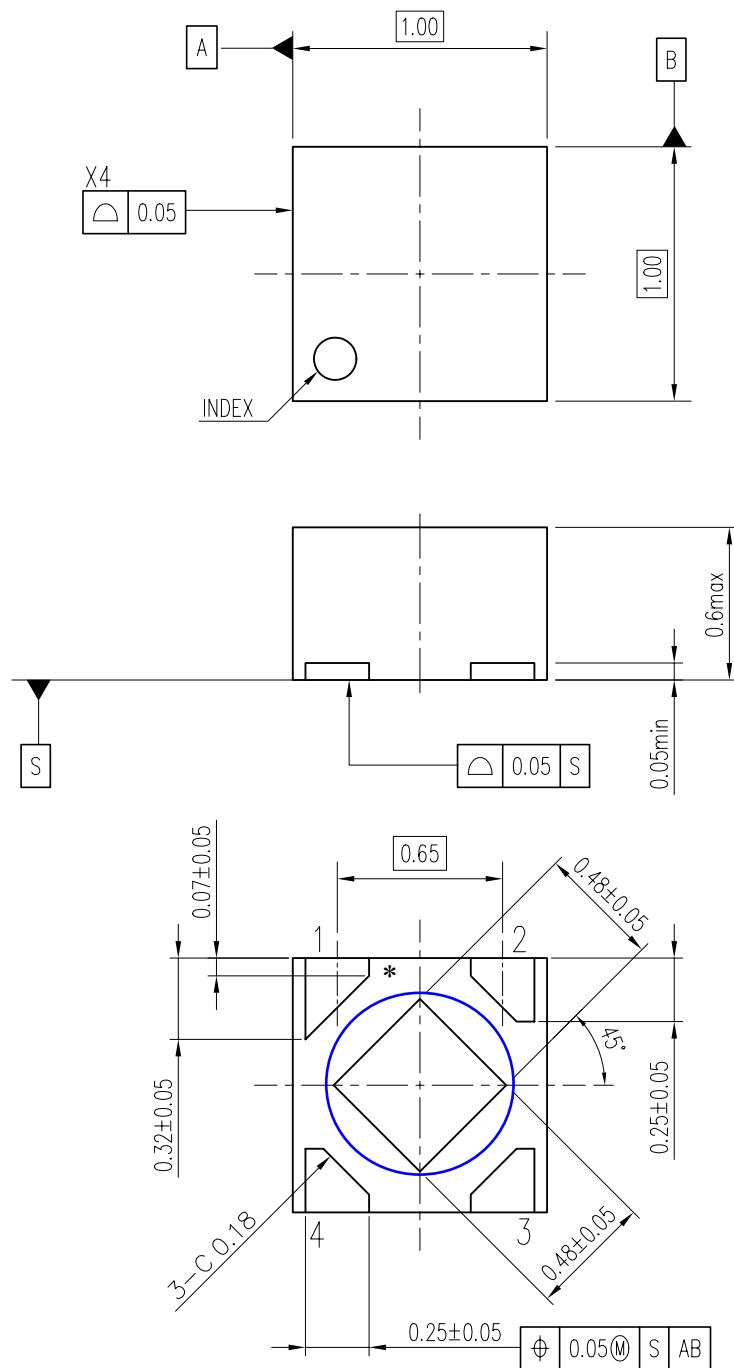
The above graph shows the power dissipation of the package at Tjmax = 125°C and Tjmax = 150°C. Operating the device in the hatched range might have a negative influence on its lifetime. The total hours of use and the total years of use must be limited as follows:

| Total Hours of Use | Total Years of Use (4 hours/day) |
|--------------------|----------------------------------|
| 13,000 hours       | 9 years                          |

# PACKAGE DIMENSIONS

# DFN(PLP)1010-4

Ver. A



DFN(PLP)1010-4 Package Dimensions (Unit: mm)

\* The tab on the bottom of the package shown by blue circle is a substrate potential (GND). It is recommended that this tab be connected to the ground plane on the board but it is possible to leave the tab floating.

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following conditions are used in this measurement.

### Measurement Conditions

| Item             | Standard Test Land Pattern                        |
|------------------|---|
| Environment      | Mounting on Board (Wind Velocity = 0 m/s)         |
| Board Material   | Glass Cloth Epoxy Plastic (Double-Sided Board)    |
| Board Dimensions | 40 mm × 40 mm × 1.6 mm                            |
| Copper Ratio     | Top Side: Approx. 50%<br>Bottom Side: Approx. 50% |
| Through-holes    | Ø 0.5 mm × 44 pcs                                 |

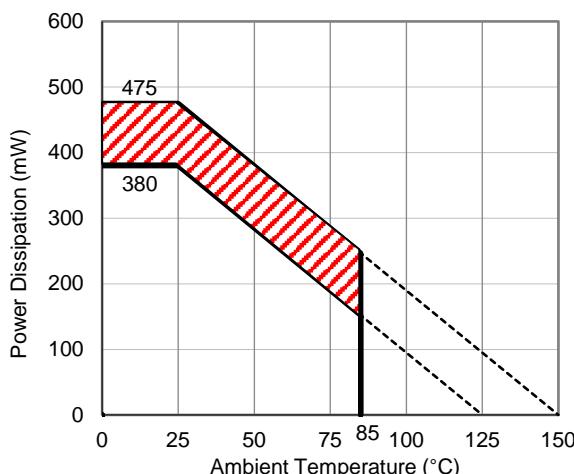
### Measurement Result

(Ta = 25°C, Tjmax = 125°C)

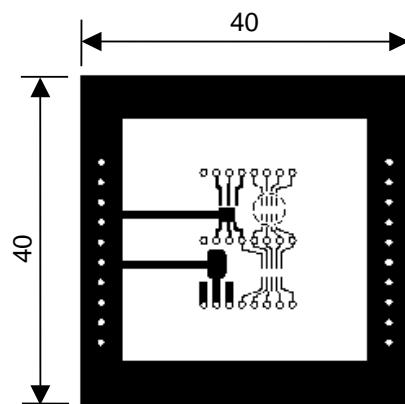
| Item   | Standard Test Land Pattern                 |
|--|--|
| Power Dissipation                                  | 380 mW                                     |
| Thermal Resistance ( $\theta_{ja}$ )               | $\theta_{ja} = 263^\circ\text{C}/\text{W}$ |
| Thermal Characterization Parameter ( $\psi_{jt}$ ) | $\psi_{jt} = 75^\circ\text{C}/\text{W}$    |

$\theta_{ja}$ : Junction-to-Ambient Thermal Resistance

$\psi_{jt}$ : Junction-to-Top Thermal Characterization Parameter



Power Dissipation vs. Ambient Temperature



Measurement Board Pattern

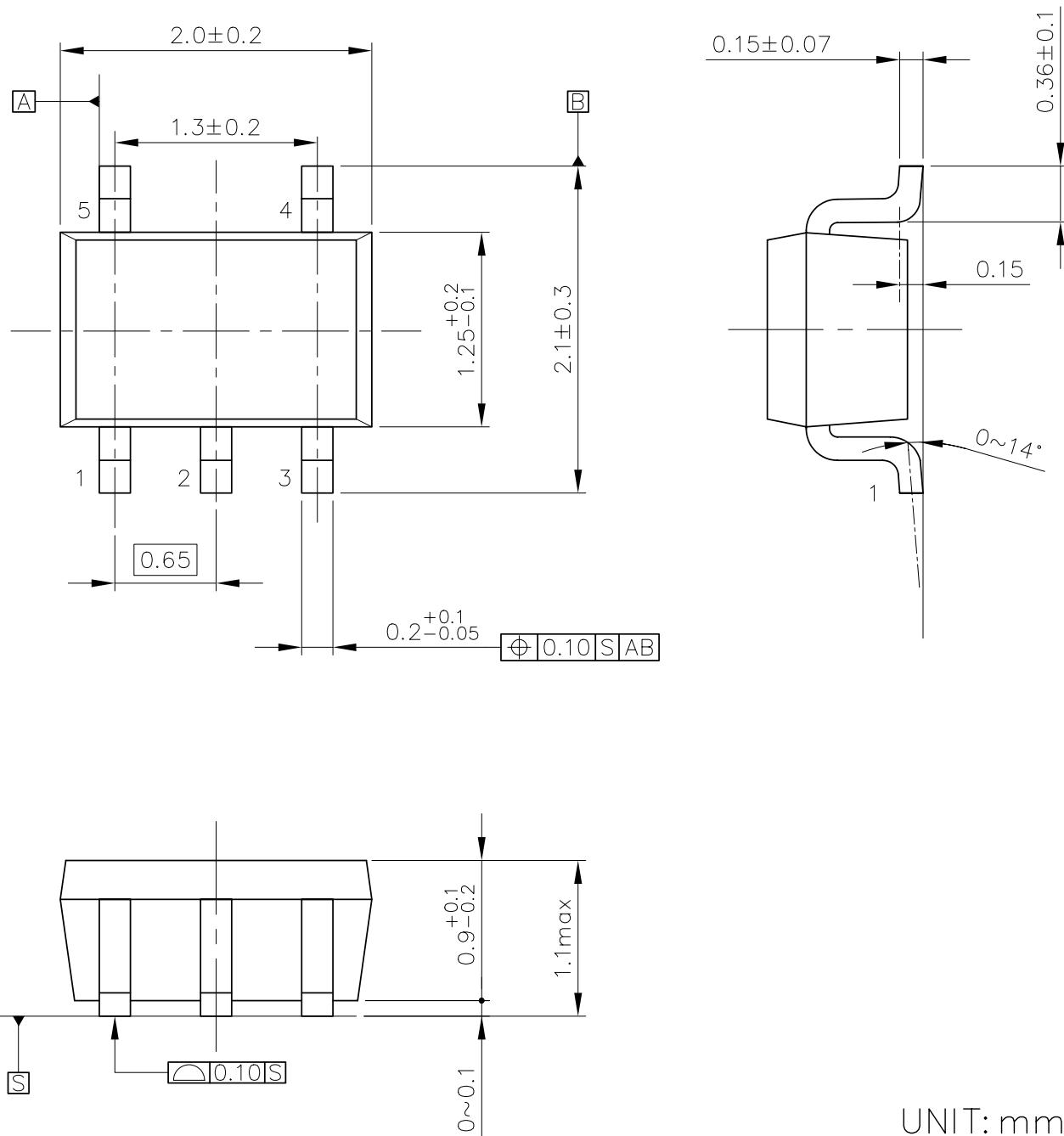
The above graph shows the power dissipation of the package at Tjmax = 125°C and Tjmax = 150°C. Operating the device in the hatched range might have a negative influence on its lifetime. The total hours of use and the total years of use must be limited as follows:

| Total Hours of Use | Total Years of Use (4 hours/day) |
|--------------------|----------------------------------|
| 13,000 hours       | 9 years                          |

# PACKAGE DIMENSIONS

SC-88A

Ver. A



SC-88A Package Dimensions

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

#### Measurement Conditions

| Item             | Measurement Conditions   |
|------------------|--|
| Environment      | Mounting on Board (Wind Velocity = 0 m/s)  |
| Board Material   | Glass Cloth Epoxy Plastic (Four-Layer Board)   |
| Board Dimensions | 76.2 mm × 114.3 mm × 0.8 mm  |
| Copper Ratio     | Outer Layer (First Layer): Less than 95% of 50 mm Square<br>Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square<br>Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square |
| Through-holes    | Ø 0.3 mm × 7 pcs   |

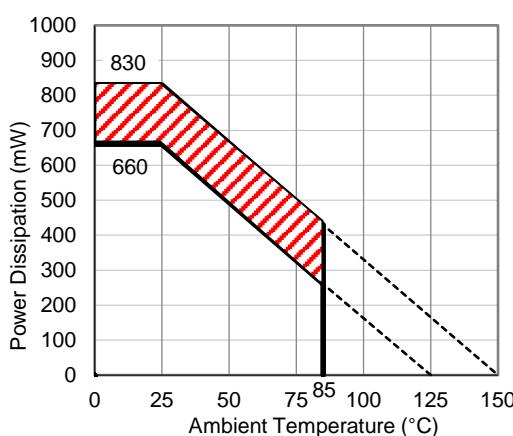
#### Measurement Result

(Ta = 25°C, Tjmax = 125°C)

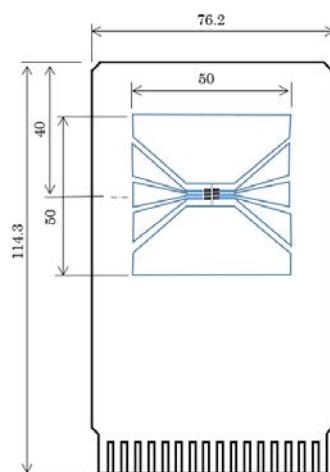
| Item   | Measurement Result                         |
|--|--|
| Power Dissipation                                  | 660 mW                                     |
| Thermal Resistance ( $\theta_{ja}$ )               | $\theta_{ja} = 150^\circ\text{C}/\text{W}$ |
| Thermal Characterization Parameter ( $\psi_{jt}$ ) | $\psi_{jt} = 51^\circ\text{C}/\text{W}$    |

$\theta_{ja}$ : Junction-to-Ambient Thermal Resistance

$\psi_{jt}$ : Junction-to-Top Thermal Characterization Parameter



Power Dissipation vs. Ambient Temperature



Measurement Board Pattern

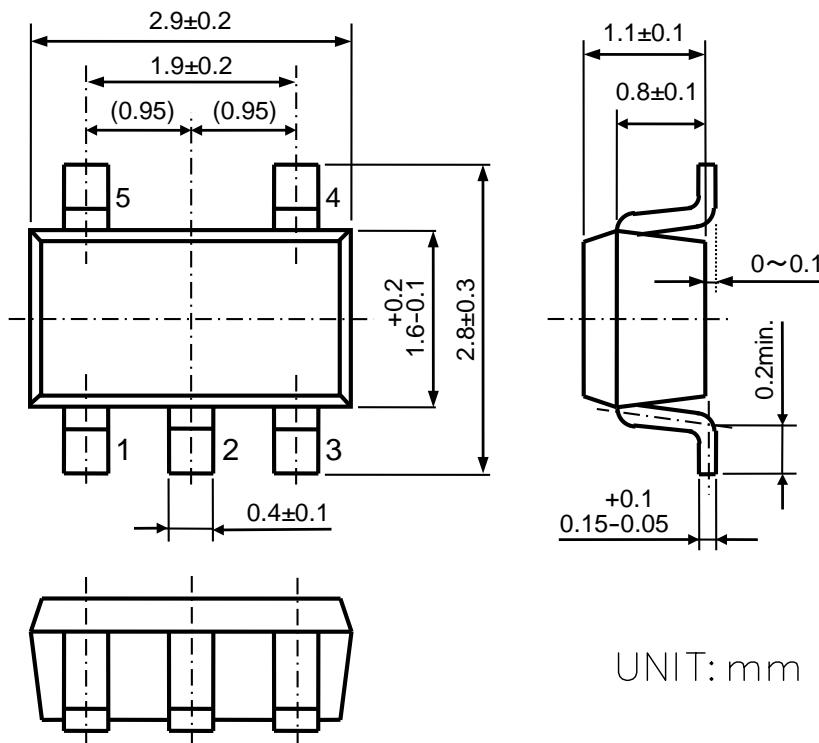
The above graph shows the power dissipation of the package at Tjmax = 125°C and Tjmax = 150°C. Operating the device in the hatched range might have a negative influence on its lifetime. The total hours of use and the total years of use must be limited as follows:

| Total Hours of Use | Total Years of Use (4 hours/day) |
|--------------------|----------------------------------|
| 13,000 hours       | 9 years                          |

## PACKAGE DIMENSIONS

SOT-23-5

Ver. A



SOT-23-5 Package Dimensions



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